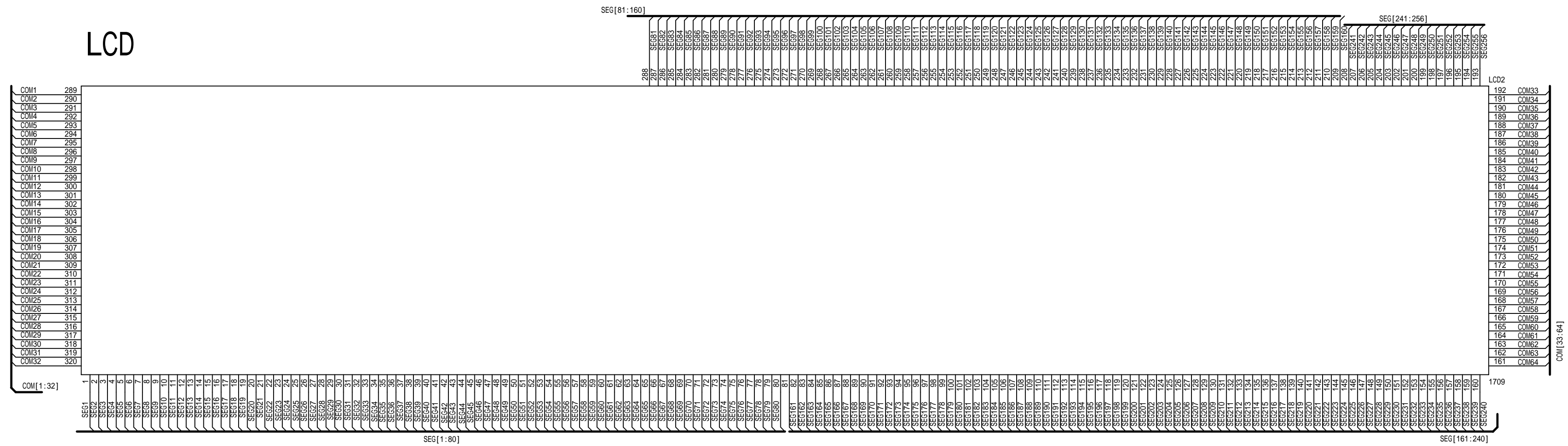


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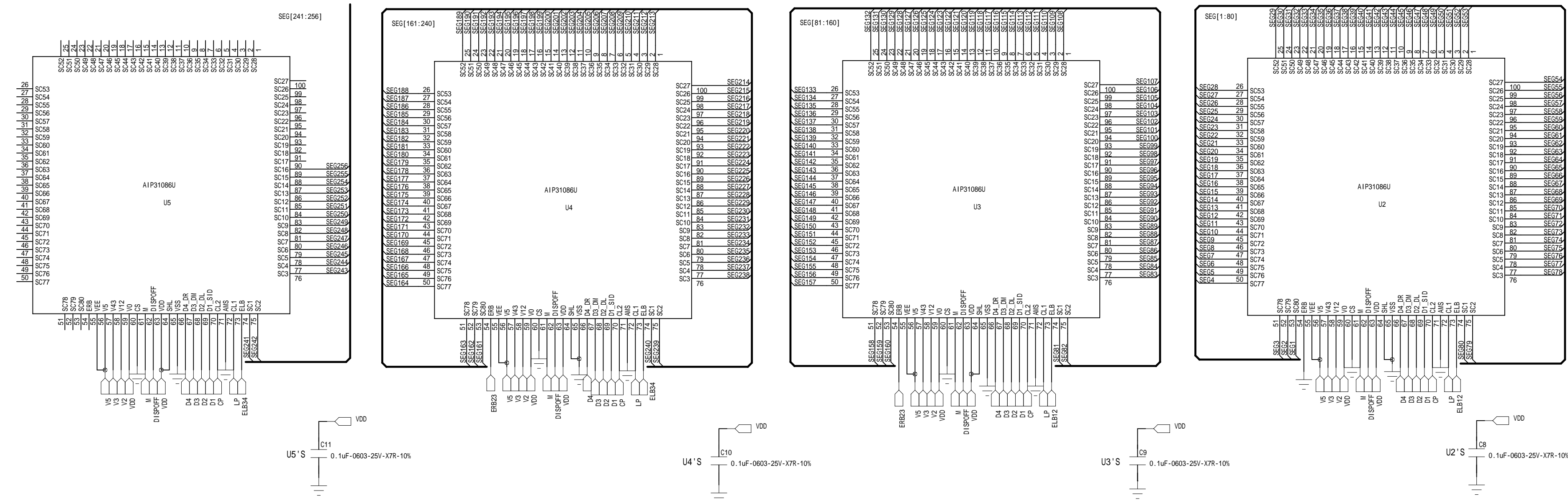
SYM	DC/EC	REV	DESCRIPTION	DATE
		DC-1	New Release	2022-09-8
		DC-2	增加背光源SGM8274有/无方案、SNC51541 增加STC8G1K08 更改分压电阻阻值	2023.2.2

LCD

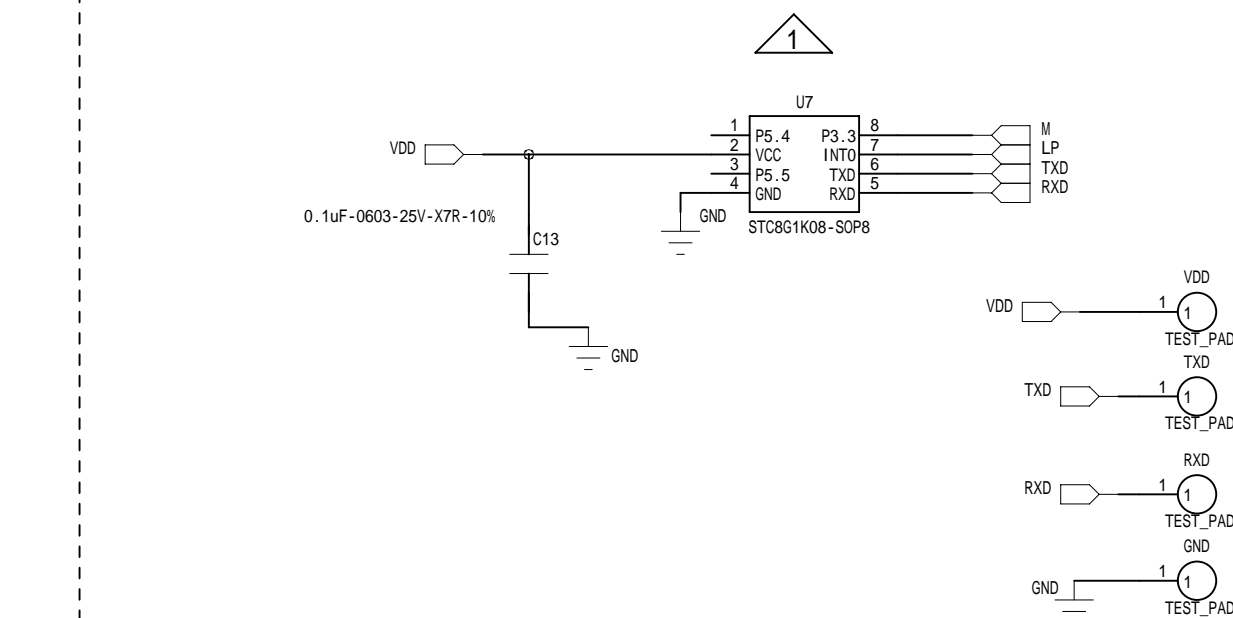


U1-U5 Substrates Should Connect To VDD

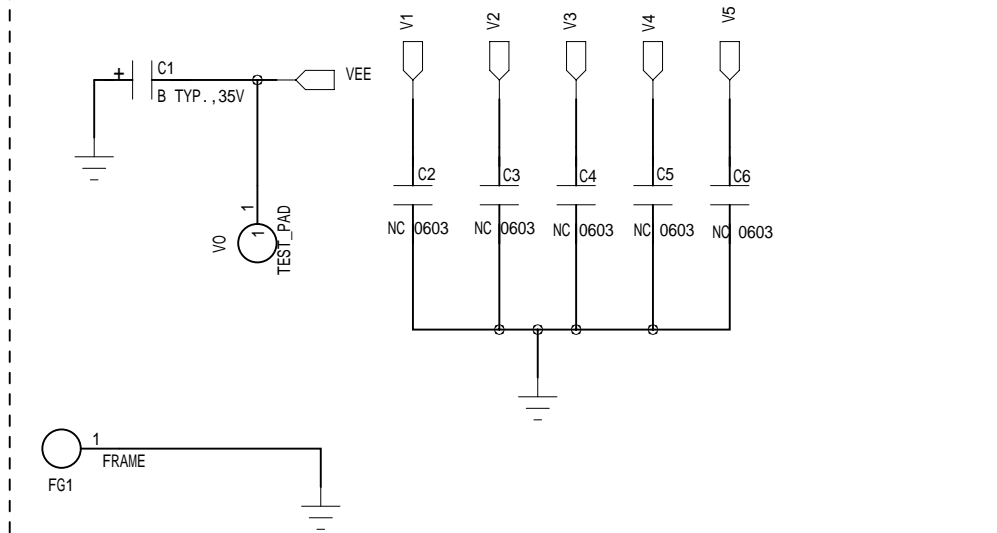
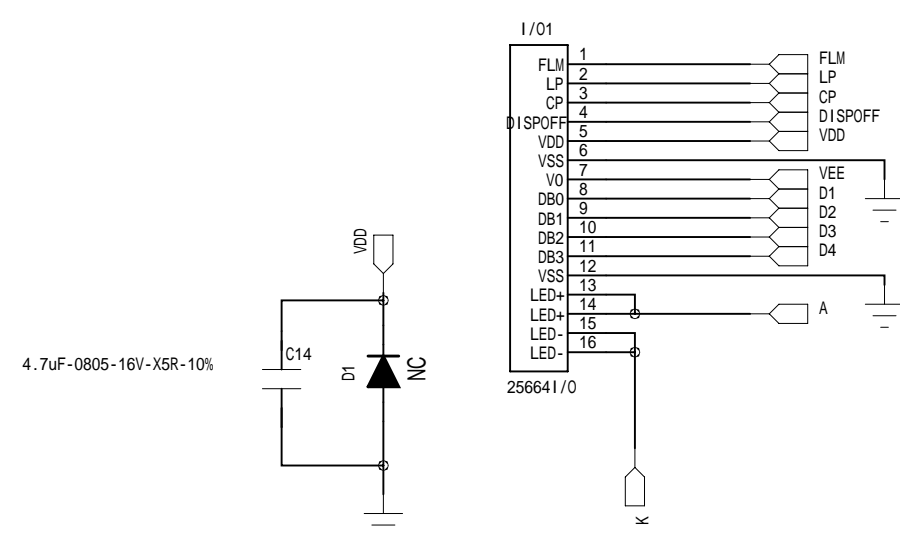
SEGMENT DRIVER



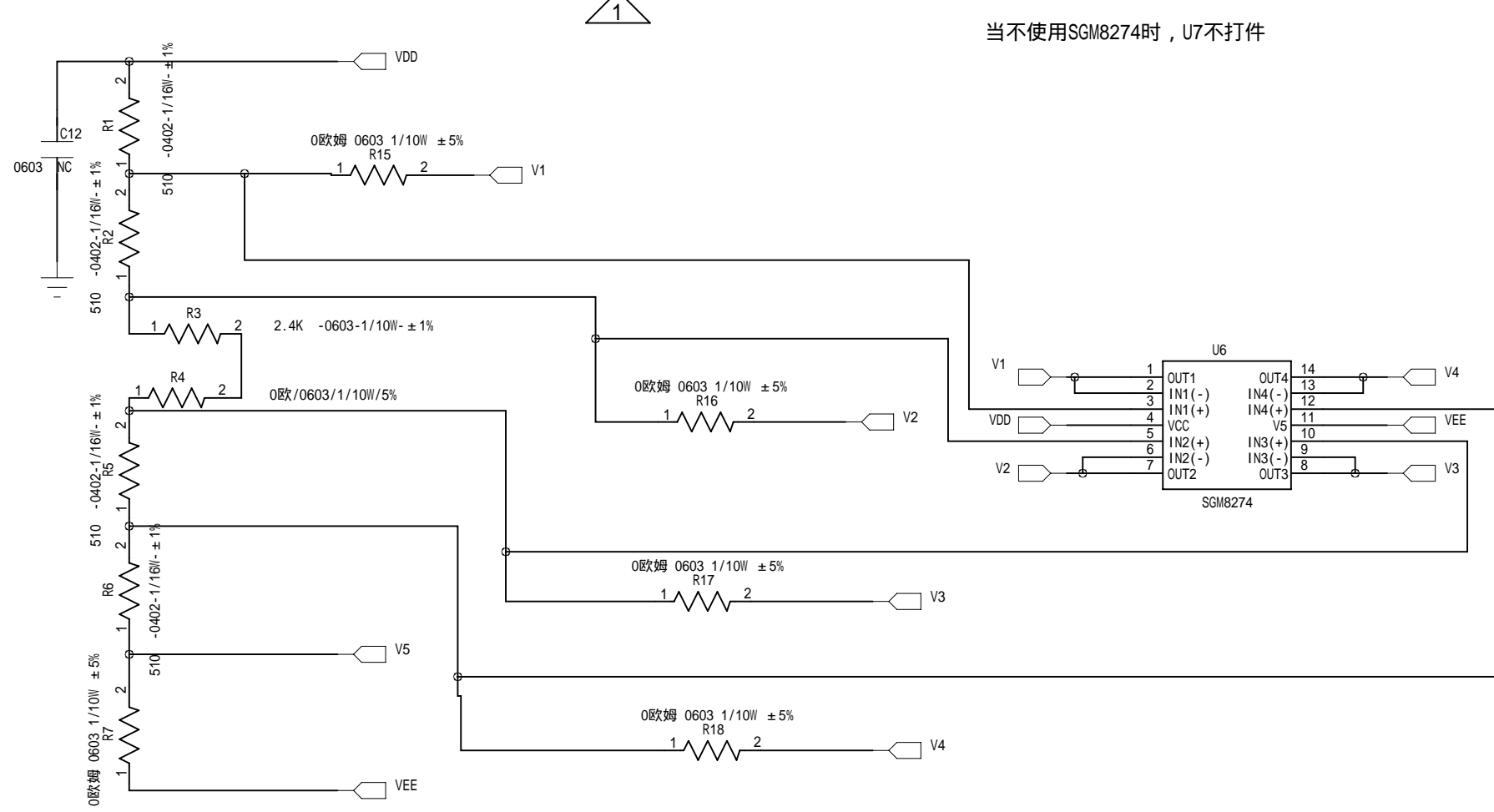
M SIGNAL CIRCUIT



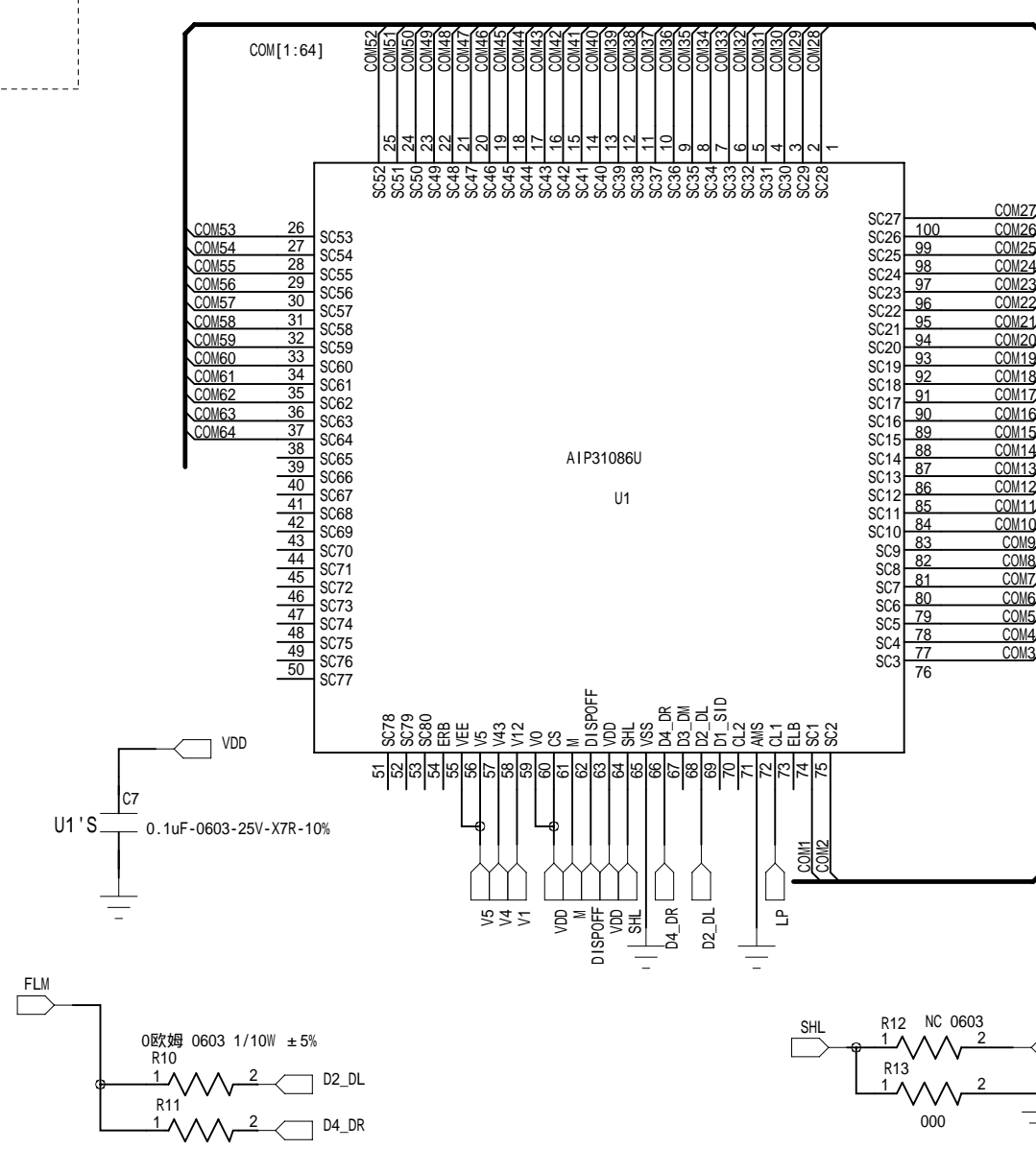
I/O PORT



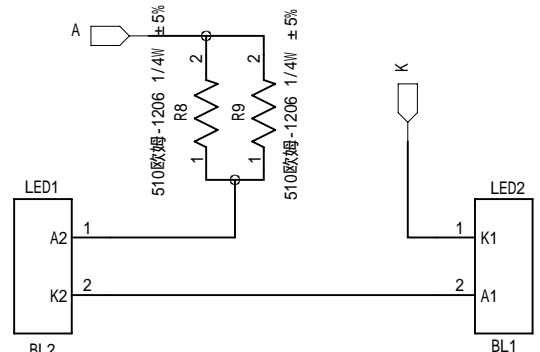
当不使用SGM8274时，U7不打件



COMMON DRIVER



BACK LIGHT



TM25664CGFWUBWA-1 PCB1-01 BOM				
原理图	名称	Pin1	规格	制作日期: 2023-2-9
Item1	IC	IC (U1-U5)	INDF-集成电路-AIP31086U(Q/S0002+HF)	数量 单位 料号
1	IC	IC (U1-U5)	INDF-集成电路-AIP31086U(Q/S0002+HF)	5 PCS 1590377590
2	电容	C14	4.7uF/0805/16V/10%/X5R	1 PCS 1530078830
3	电容	C7,C11,C13	0.1uF/0603/25V/10%/X7R	6 PCS 1530077000
4	电阻	R1,R2,R5,R6	INDF-电阻-510Q-0603-1/10W/±1%/Q/S0002+HF)	4 PCS 1530035680
5	电阻	R3	INDF-电阻-2.4KQ-0603-1/10W/±1%/Q/S0002+HF)	1 PCS 1530366070
6	电阻	RA,R7,R10,R13, R15, R16, R17, R18	08Q/0603/1/10W/5%	8 PCS 1530086520
7	电阻	R8,R9	510ΩE/1206/1/4W/5%	2 PCS 1530081860
8	PCB	PCB	INDF-PCB-信号处理基板-TM25664CGFWUBWA-1 PCB1-00(Q/S0002)	1 PCS 1560399000
9	硅胶	硅胶	INDF-硅胶-EOT016(1HNEOT016康恩5.44kg)- (Q/S0002+HF)	0.645 PCS 1520318500
10	焊接材料	焊接材料	INDF-焊接材料-ABW/AL-301/CCT1.0mm(电阻率762米)- (Q/S0002+HF)	0.0004 PCS 16300000210
11	电容	C1,C6,C12	NC	0 PCS /
12	电阻	R11,R12	NC	0 PCS /
13	二极管	D1	NC	0 PCS /
14	MCU	U7	STC8G1K08-SOP8	1 PCS 1590380600
15	IC	U6	INDF-集成电路-PowerIC-IC-SGM8274YS	0 pcs 1590367070
Note 其中电阻C1-C6,C12, 电阻R11,R12, 二极管D1, 都不打件。 U6不打件。				
环保要求: Q/S0002				

TIANMA			
DRAWN BY: YuYanq	2023/02/9	TITLE: TM25664CGFWUBWA-1 DC-2	
CHECKED BY: ZhangYufeng	2023/02/9	PURPOSE: FOR FPC	
APPROVED BY: DengZhibin	2023/02/9	UNIT: SCALE: SHEET NO: 1 OF 1	